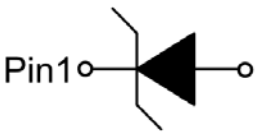
1- Line, Uni-directional, Transient Voltage Suppressor





SOD-323

Features

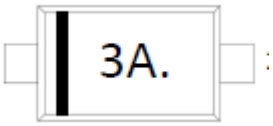
- Stand-off voltage: 3.3V Max
- Transient protection for each line according to
  IEC61000-4-2(ESD): ±30kV (contact)
  IEC61000-4-5(surge): 28A (8/20μs)
- Low leakage current:
- Ultra low clamping voltage
- RoHS Compliant

Applications

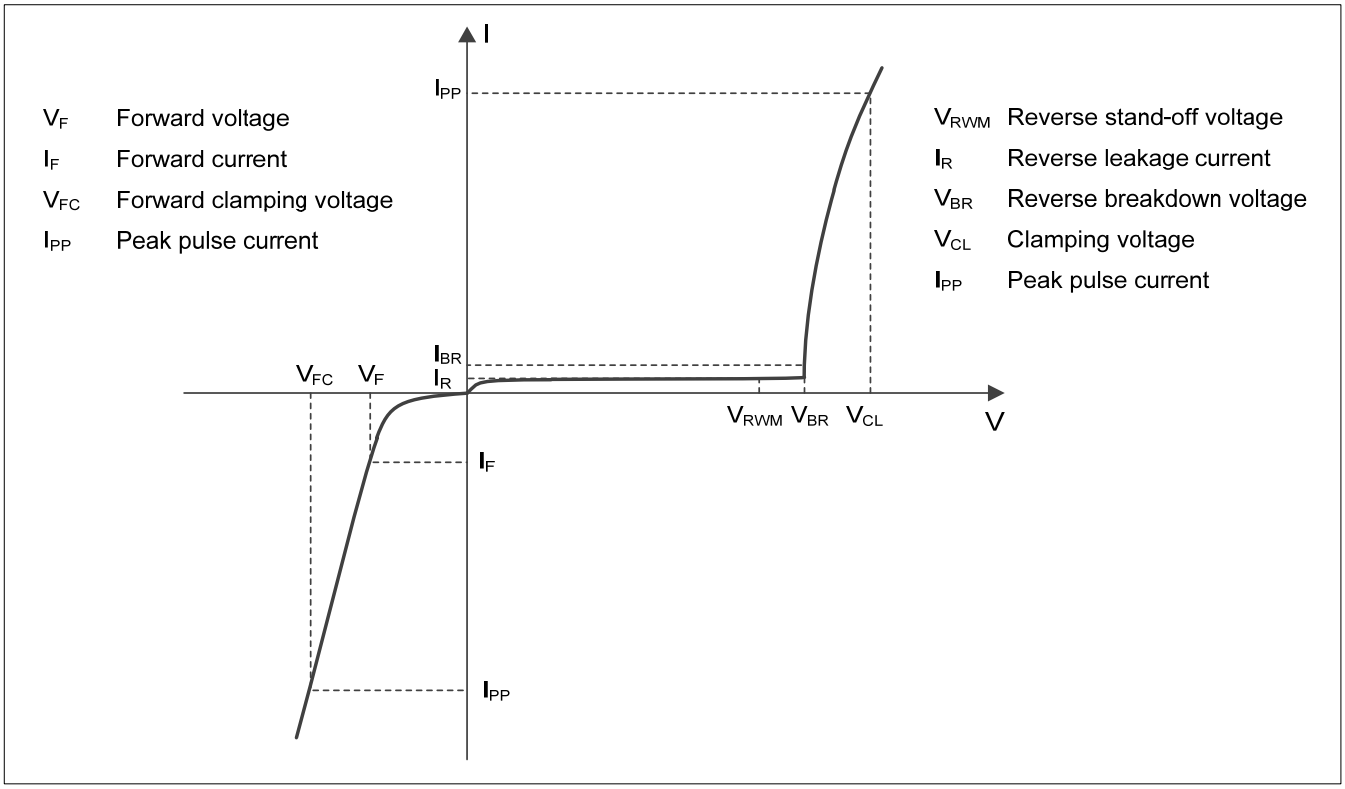
- Cellular Handsets and Accessories
- Personal Digital Assistants
- Notebooks and Handhelds
- Portable Instrumentation
- Digital Cameras
- Peripherals
- Audio Players

Mechanical Data

- Package: SOD-323
- Lead Finish: Matte Tin
- Case Material: “Green” Molding Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Marking Information: See Below



■Definitions of electrical characteristics



■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power (t_p = 8/20μs)	P_{pk}	364	W
Peak pulse current (t_p = 8/20μs)	I_{PP}	28	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±30	KV
ESD according to IEC61000-4-2 contact discharge		±30	
Junction temperature	T_J	-55~125	ºC
Storage temperature	T_{STG}	-55~150	ºC

■Electrical Characteristics（T_a=25℃ Unless otherwise specified）

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				3.3
Forward Voltage	VF	V	IF = 10mA			1.2
Reverse leakage current	I_R	μA	V_{RWM} = 3.3V			0.5
Reverse breakdown voltage	V_{BR}	V	I_{BR} = 1mA	4.5		
Dynamic resistance [1]	R_{DYN}	Ω			0.4	
Clamping voltage [2]	V_{CL}	V	I_{PP} = 1A, t_p = 8/20μs		6.5	7
		V	I_{PP} = 28A, t_p = 8/20μs		11	13
Junction capacitance	C_J	pF	V_R = 0V, f = 1MHz		180	200

Notes:
(1). TLP parameter: Z_0 = 50Ω, t_p = 100ns, t_r = 2ns, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.
(2). Non-repetitive current pulse, according to IEC61000-4-5.
.

■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD3V3D3A	F2	Approximate 4	3000	30000	120000	7 reel

■ Characteristics (Typical)

Fig.1 8/20μs waveform per IEC61000-4-5

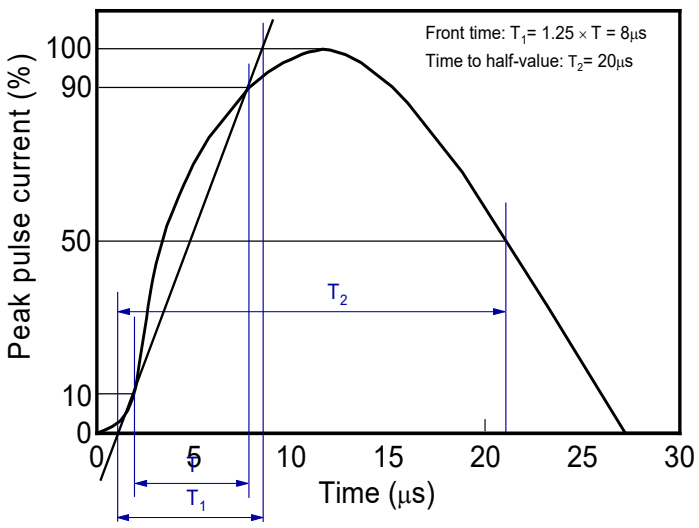


Fig.2 Contact discharge current waveform per IEC61000-4-2

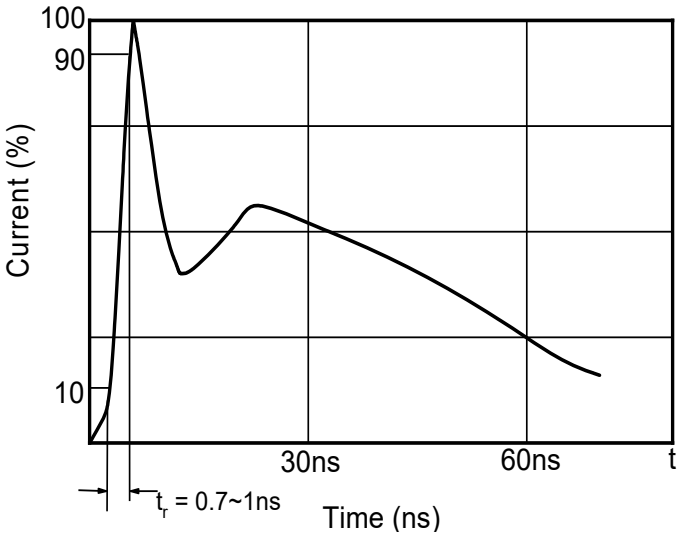


Fig.3 Clamping voltage vs. Peak pulse current

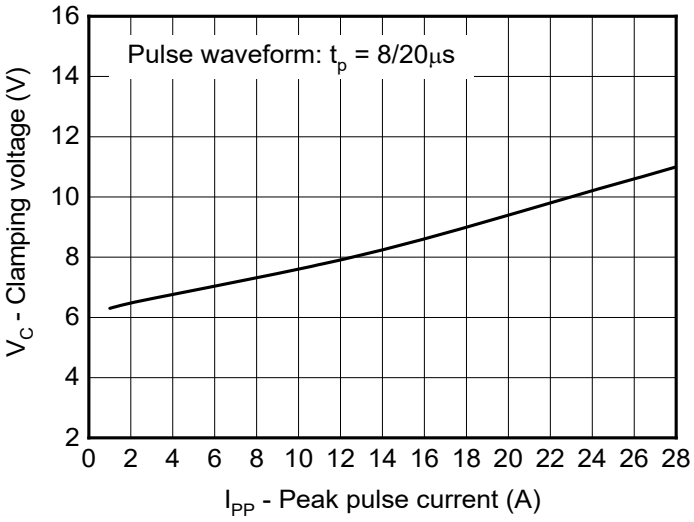


Fig.4 Capacitance vs. Reverse voltage

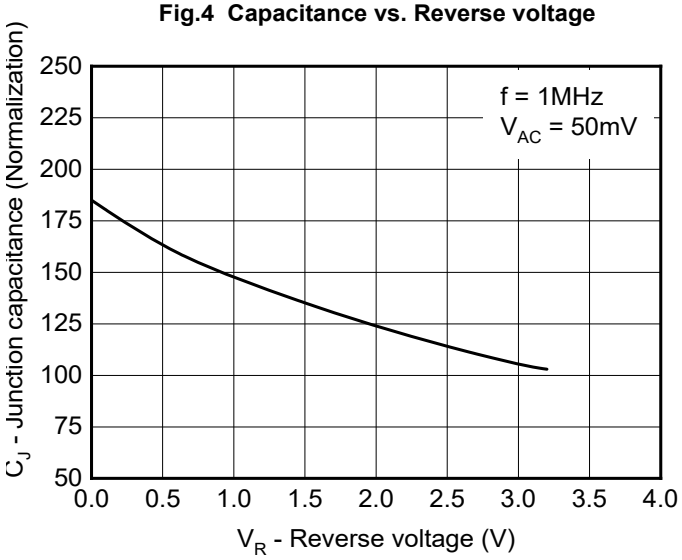


Fig.5 Non-repetitive peak pulse power vs. Pulse time

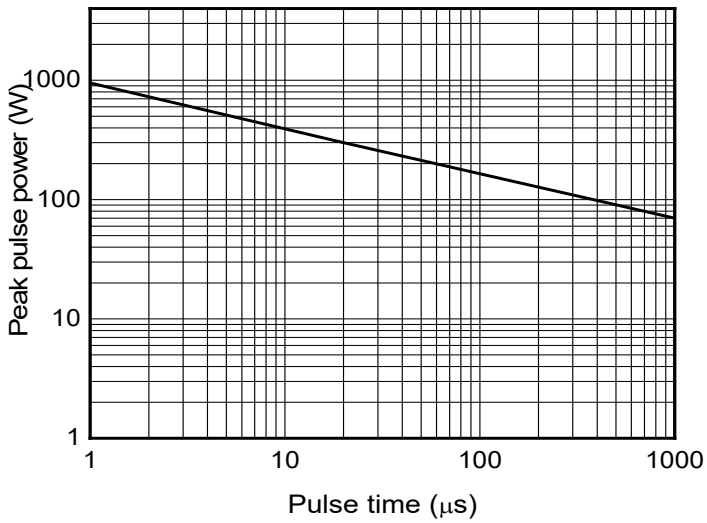
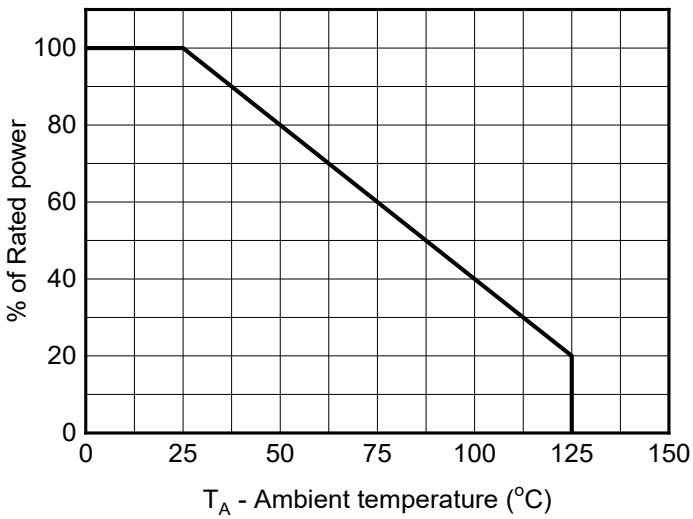
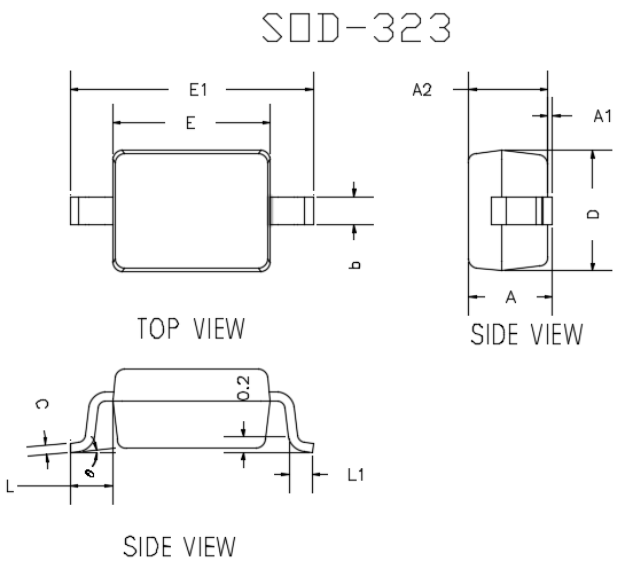


Fig.6 Power derating vs. Ambient temperature

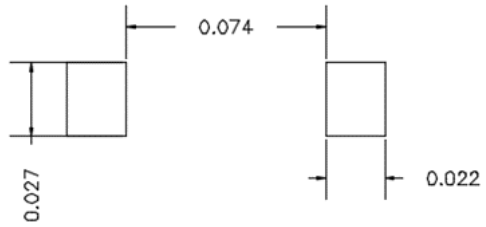


■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MN	MAX
A	---	0.0393	---	1.0000
A1	0.0000	0.0039	0.0000	0.1000
A2	0.0314	0.0354	0.8000	0.9000
b	0.0098	0.0157	0.2500	0.4000
c	0.0031	0.0059	0.0800	0.1500
D	0.0472	0.0551	1.2000	1.4000
E	0.0629	0.0709	1.6000	1.8000
E1	0.0984	0.1063	2.5000	2.7000
L	0.0187TYP		0.475TYP	
L1	0.0098	0.0157	0.250	0.400
θ	0°	8°	0°	8°

■ Soldering Footprint



UNIT：inch
SUGGESTED SOLDER PAD LAYOUT

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